Docket No. **TS02-096**

Sir:

Transmitted herewith for filing is the Patent Application of:

Inventor: TZONG-SHI JAN

For: A MULTI-LAYERED METAL ROUTING TECHNIQUE



Enclosed are:							
X	X 11 sheets of drawing(s) - formal.						
X	An assignment of the invention to Taiwan Semicondutor Manufacturing Co.						
	An associate power of attorney Applicant claims small entity status						
	Request & Certification under 35 USC 122(b)(2)(b)(i)						
The filing fee has been calculated as shown below:							
		(Col. 1)	(Col. 2)	OTHER THAN	A SMALL ENTITY		
FOR:	!	NO. FILED	NO. EXTRA	RATE	FEE		
BASIC FEE		> <			\$ 750.		
TOTAL	L CLAIMS	34 -20=	14	x 18 ≈	\$ 2 5 2.		
	CLAIMS	9 -3=	6	x 84 =	\$ 504.		
				SUB TOTAL	\$ 1,506.		
				SSIGNMENT \$40.			
			Γ	TOTAL	\$ 1.546.		
X	Please charge my Deposit Account No. 19-0033 in the amount of \$ 1,546. A duplicate copy of this sheet is enclosed.						
X	The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any						
	overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.						
	X Any additional filing fees required under 37 CFR §1.16.						
	X Any patent application processing fees under 37 CFR §1.17.						
Respectful V whmitted							

EXPRESS MAIL CERTIFICATE

B. ACKERMAN, REG. NO. 37,761

Express Mail No. EV313927012US

I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Assistant Commissioner of Patents, Alexandria, VA, 22313-1450. Applicant and/or Attorney requests the date of deposit as the Filing Date.

Date of deposit

Signature / Date